



# DSG Projects FY 2023

Dr. Patrizia Rossi

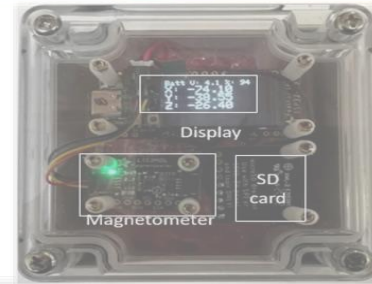
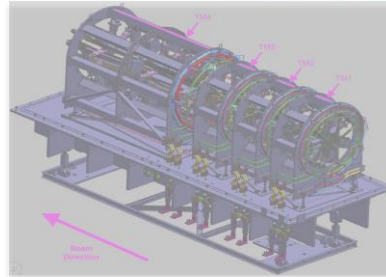
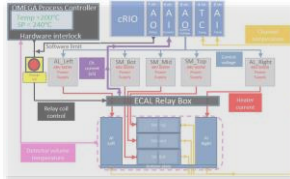
Detector Support Group

Tuesday, October 10, 2023

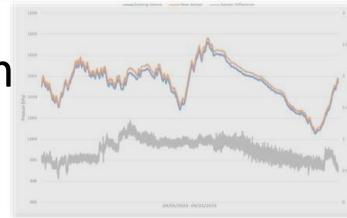
# Contributions



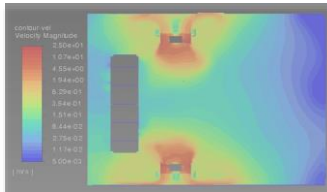
- **Hall A**
  - Møller and CLEO magnets
  - ECAL



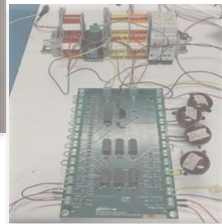
- **Hall B**
  - Environment Monitoring System



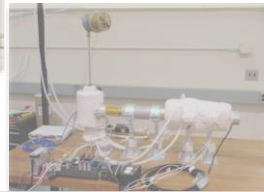
- **Hall C**
  - NPS



- **Hall D**
  - FCAL 2



- **EIC**
  - DIRC
  - Beampipe Test Stand



- **DSG R&D**
  - Phoebus Alarm System

DSG-C-NPS Alarm Area Panel		
Crystal Zone Back Temperatures	Crystal Zone Chiller Coolant	Crystal Zone Cooling Temperatures
Crystal Zone Front Temperatures	Detector Frame Dew Points	Detector Frame Humidity
Detector Frame Temperatures	Electronics Zone Chiller Coolant	Electronics Zone Temperatures
Hall Dew Points	Hall Humidity	Hall Temperatures



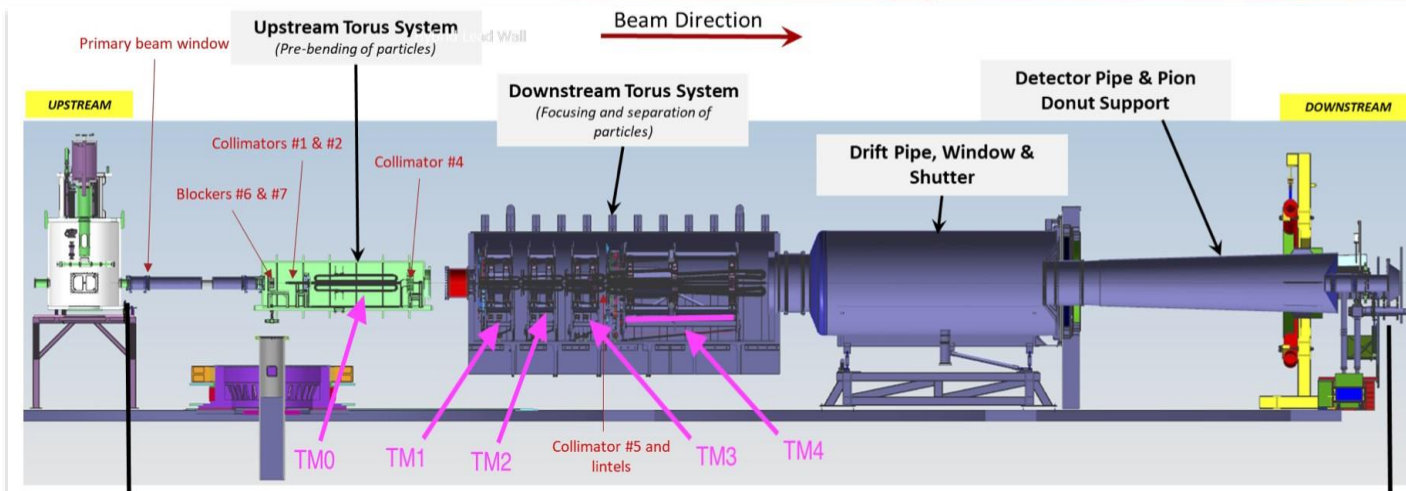
# Hall A - Magnets

Eng and Antonioli



## Møller magnets

- Set up communications between Siemens S7-1500 PLC controller and EPICS softIOC
- Developing instrumentation and control wiring diagrams
  - Drawings of temperature sensors and hardware voltage taps – complete
  - Drawings of voltage tap for PLC – in progress
- Developing CSS Phobus screens for monitoring
  - Magenta boxes in the screens to the right are shown instead of values because EPICS softIOC is not running



**Torus Magnet 4 Voltage Taps [V]**

**Torus Magnet 1 Temperatures [°C]**

**Torus Magnets' Voltage Taps [V]**

	TM 1	TM 2	TM 3	TM 4
Splice in	<smaller>	<smaller>	<smaller>	<smaller>
Splice out	<smaller>	<smaller>	<smaller>	<smaller>
WCL supply	<smaller>	<smaller>	<smaller>	<smaller>
WCL return	<smaller>	<smaller>	<smaller>	<smaller>
Whole magnet	<smaller>	<smaller>	<smaller>	<smaller>
Coil A	<smaller>	<smaller>	<smaller>	<smaller>
Coil A left	<smaller>	<smaller>	<smaller>	<smaller>
Coil A right	<smaller>	<smaller>	<smaller>	<smaller>
Coil B	<smaller>	<smaller>	<smaller>	<smaller>
Coil B left	<smaller>	<smaller>	<smaller>	<smaller>
Coil B right	<smaller>	<smaller>	<smaller>	<smaller>
Coil C	<smaller>	<smaller>	<smaller>	<smaller>
Coil C left	<smaller>	<smaller>	<smaller>	<smaller>
Coil C right	<smaller>	<smaller>	<smaller>	<smaller>
Coil D	<smaller>	<smaller>	<smaller>	<smaller>
Coil D left	<smaller>	<smaller>	<smaller>	<smaller>
Coil D right	<smaller>	<smaller>	<smaller>	<smaller>
Coil E	<smaller>	<smaller>	<smaller>	<smaller>
Coil E left	<smaller>	<smaller>	<smaller>	<smaller>
Coil E right	<smaller>	<smaller>	<smaller>	<smaller>
Coil F	<smaller>	<smaller>	<smaller>	<smaller>
Coil F left	<smaller>	<smaller>	<smaller>	<smaller>
Coil F right	<smaller>	<smaller>	<smaller>	<smaller>
Coil G	<smaller>	<smaller>	<smaller>	<smaller>
Coil G left	<smaller>	<smaller>	<smaller>	<smaller>
Coil G right	<smaller>	<smaller>	<smaller>	<smaller>
Coil A-B	<smaller>	<smaller>	<smaller>	<smaller>
Coil B-C	<smaller>	<smaller>	<smaller>	<smaller>
Coil C-D	<smaller>	<smaller>	<smaller>	<smaller>
Coil D-E	<smaller>	<smaller>	<smaller>	<smaller>
Coil E-F	<smaller>	<smaller>	<smaller>	<smaller>
Coil F-G	<smaller>	<smaller>	<smaller>	<smaller>
Coil G-A	<smaller>	<smaller>	<smaller>	<smaller>

Phobus voltage tap screen for Magnet 4

Phobus coil temperature screen for Magnet 1

Phobus voltage tap summary



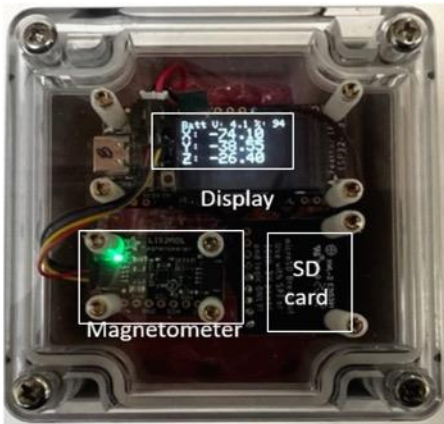
# Hall A - Field Mapping of SoLID aka CLEO



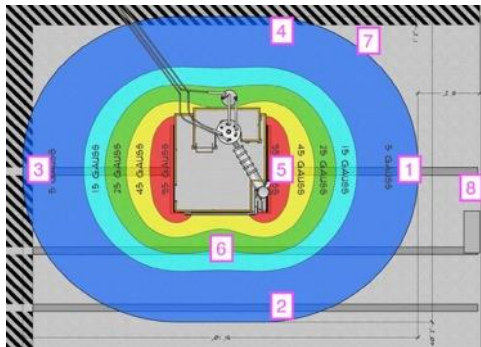
Eng and Leffel

## Researched , designed, fabricated, installed, acquired data, and analyzed CLEO field

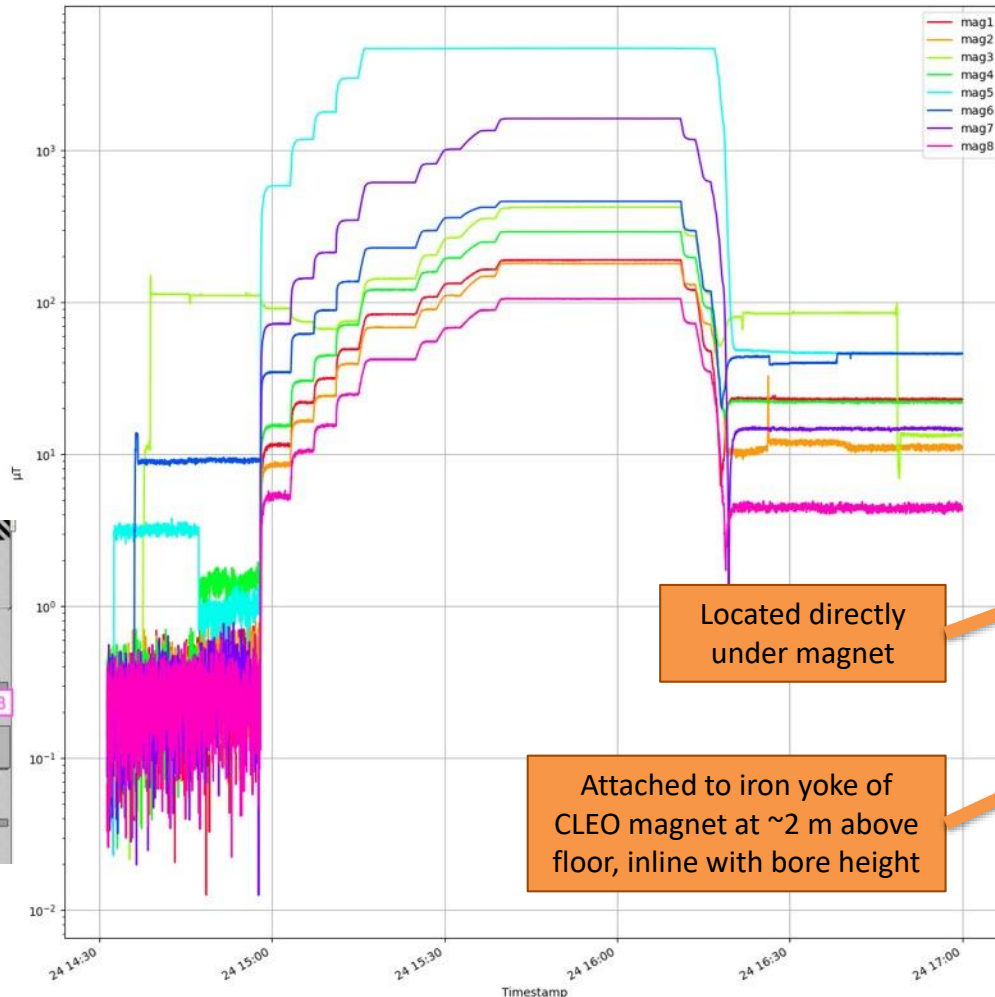
- Designed, fabricated, and deployed eight field–mapping units to measure  $B$  during  $\sim 100$  A test
  - Fringe field after powering down the magnet is around the earth’s magnetic field 0.25 G–0.65 G



Field mapping unit



Location of units



Located directly under magnet

Attached to iron yoke of CLEO magnet at  $\sim 2$  m above floor, inline with bore height

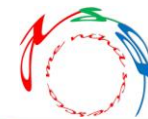
Unit	Max Field (G)
1	1.90
2	1.81
3	4.28
4	2.92
5	46.98
6	4.62
7	16.20
8	1.05

Maximum field recorded

Field magnitude in  $\mu\text{T}$  for each unit during magnet ramp up and down

# Hall A - ECAL Six-Supermodule Heater

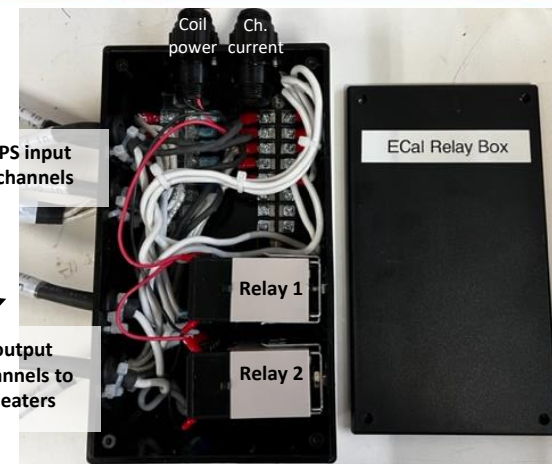
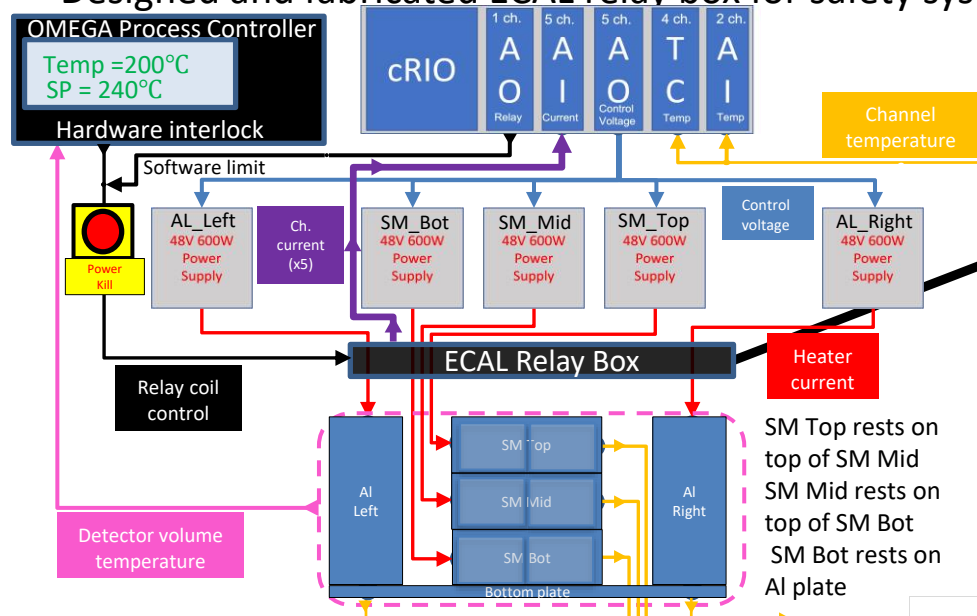
McMullen, Eng, and Leffel



## Developed PID control, monitoring, and safety system

– Heater controls has five channels each with individual PID controls

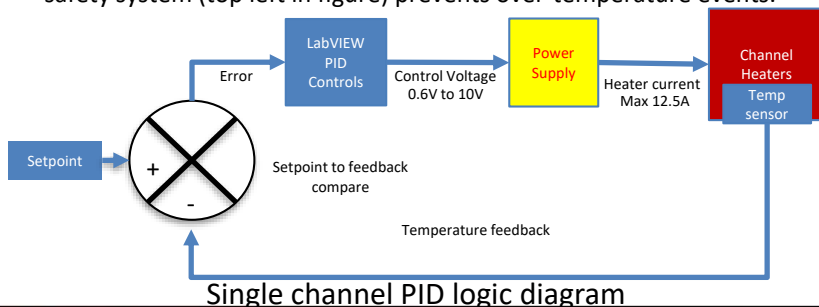
- Designed and fabricated ECAL relay box for safety system



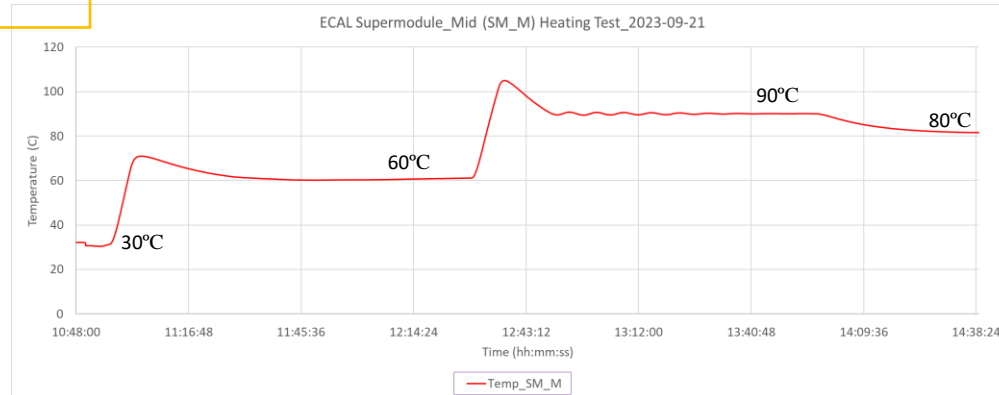
ECAL relay box

- Relays open to prevent over-temperature event
- Each heater control channel has an input from the power supply and an output to the heater
  - Relay 1 is for the three supermodule heater channels
  - Relay 2 is for the two aluminum bar heater channels
- Each channel has a hall probe to measure current (not visible)

Super modules (SM) set up in a (3x2) configuration with AI bars on left and right for support. The three rows of SM and the two columns of AI support are independently powered. The Omega process controller safety system (top left in figure) prevents over-temperature events.



Single channel PID logic diagram



Heating test, over a range of temperatures <100°C, demonstrates PID control works for the middle supermodule (SM\_M)



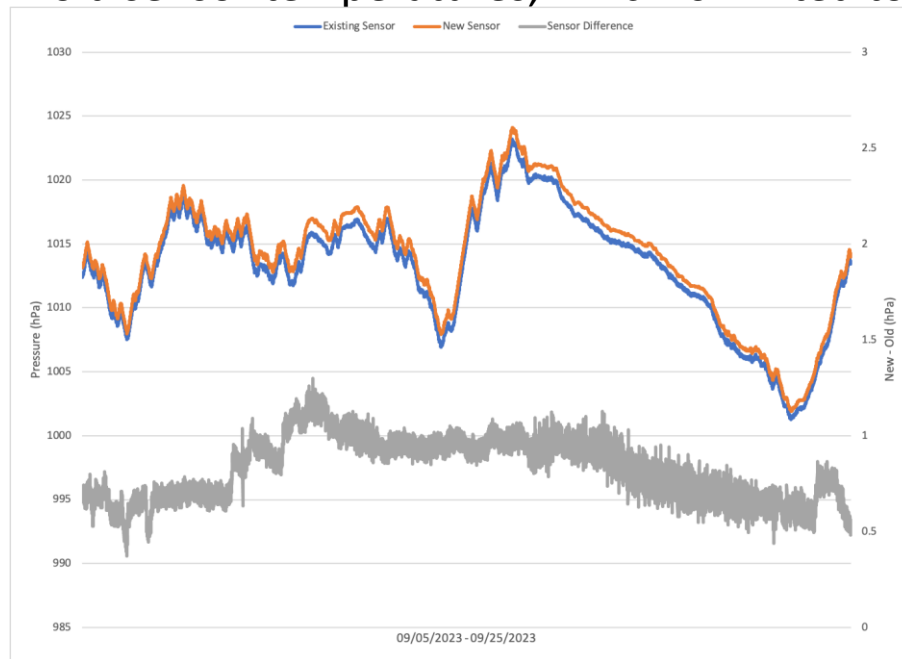
# Hall B - Environment Monitoring System



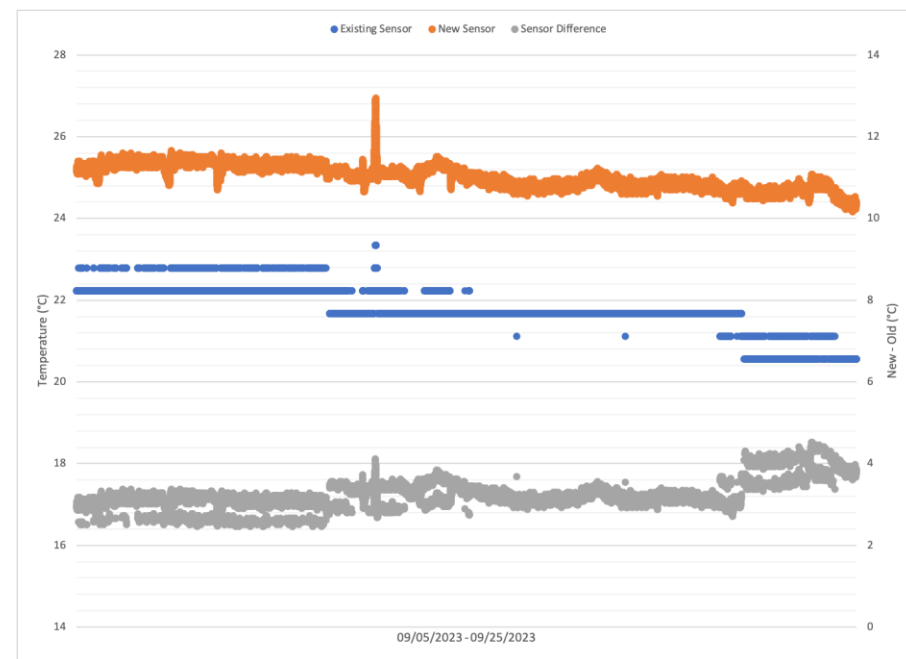
Eng

## Researched, designed, and implemented environment monitoring system

- Bosch BMP390 sensor system configured and deployed
  - System has Olimex ESP32-POE-ISO microcontroller
    - Allows a single cable for networking and power
  - Bosch has a pressure and temperature accuracy of  $\pm 3$  Pa and  $\pm 0.5^\circ\text{C}$
- EPICS output of the Bosch pressure measurements and old sensors agree with each other
- EPICS output of Bosch temperature measurements has better resolution than EPICS output of old sensor temperatures, which is limited to  $1^\circ\text{F}$



Pressure comparison



Temperature comparison

Existing sensor data converted to match units of new sensors



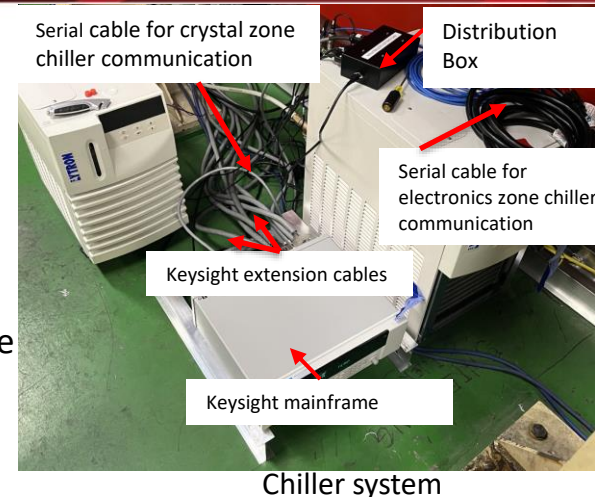
# Hall C – NPS Controls and Monitoring System



**Brown, Antonioli, and Bonneau**

## Designed, coded, and installed control and monitoring system

- Fabricated distribution box
  - Provides +24 V to external flowmeters of the crystal and electronics zone chillers, which are read out using the Keysight mainframe
- Developed EPICS Phoebus GUIs to control and monitor temperature, relative humidity, and dewpoint
  - Phoebus screens for control and monitoring temperatures of back crystal zone shown below has been implemented in the Hall
  - Values shown in the monitoring screen below are values read in real time by the system



### Control

Crystal	Alarm limit [°C]		Sensor enable	Avg enable	# of pts. to avg	Intlk enable	Trip delay enable	Trip delay time [s]	Crystal	Alarm limit [°C]		Sensor enable	Avg enable	# of pts. to avg	Intlk enable	Trip delay enable	Trip delay time [s]
	low	high								low	high						
0	0	30	Enabled	Enabled	300	Enabled	Enabled	30	540	0	30	Enabled	Enabled	300	Enabled	Enabled	30
5	0	30	Enabled	Enabled	300	Enabled	Enabled	30	550	0	30	Enabled	Enabled	300	Enabled	Enabled	30
10	0	30	Enabled	Enabled	300	Enabled	Enabled	30	560	0	30	Enabled	Enabled	300	Enabled	Enabled	30

### Monitoring

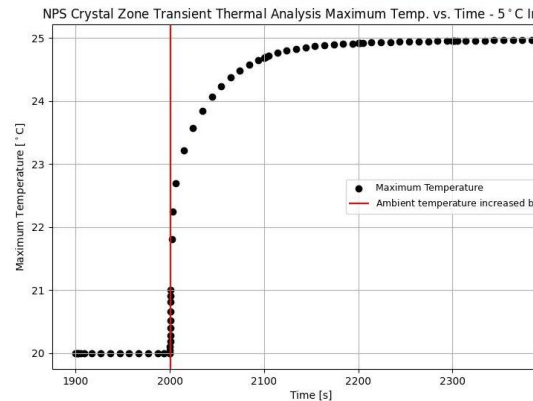
Crystal	T [°C]	Avg [°C]	σ [°C]	Intlk status	Latch status	Crystal	T [°C]	Avg [°C]	σ [°C]	Intlk status	Latch status
5	21.73	22.14	0.35	Enabled	Enabled	550	16.49	15.63	0.49	Enabled	Enabled
10	21.40	21.70	0.29	Enabled	Enabled	560	14.91	13.61	0.78	Enabled	Enabled

High and low temperature alarm limits can be set (blue box, top screenshot). Monitored rolling average of temperatures (over 300 measurements; red box, bottom screenshot). With interlock enabled, if average temperature >30°C, high voltage trips after 30 s

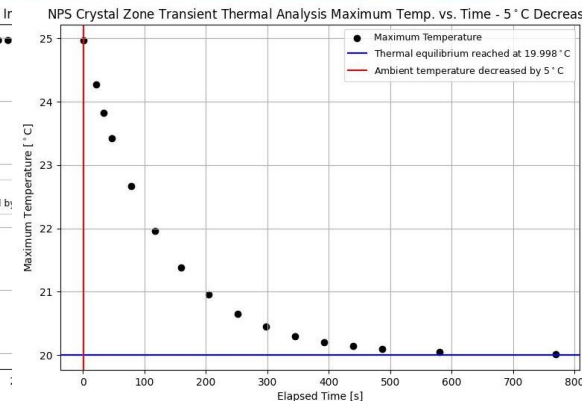


## Ansys thermal analysis

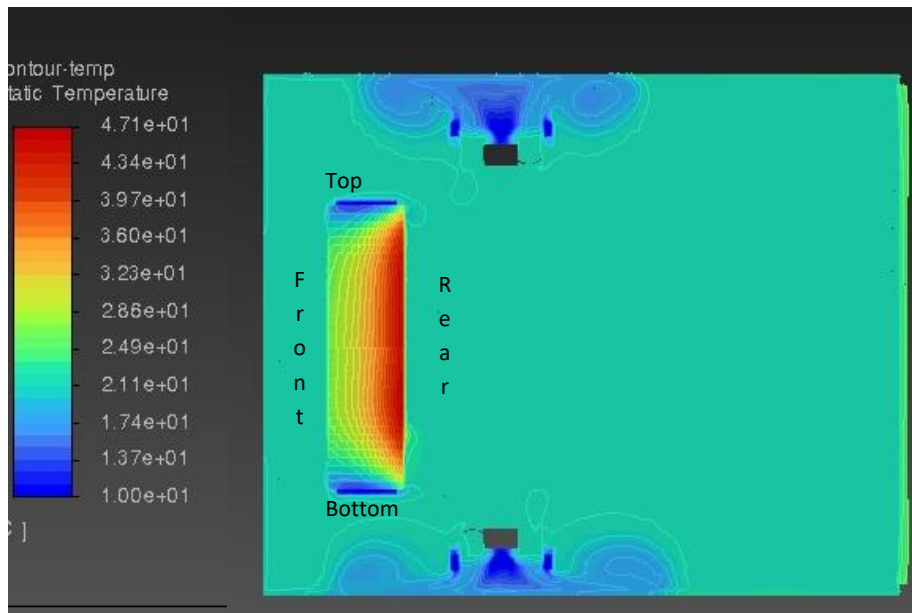
- Ansys **Mechanical** transient analysis results concur with steady-state analysis results
- Ansys **Fluent** steady state model includes all required material thermal properties, cell conditions, boundary conditions and **Shell Conduction** features
  - Result is being analyzed



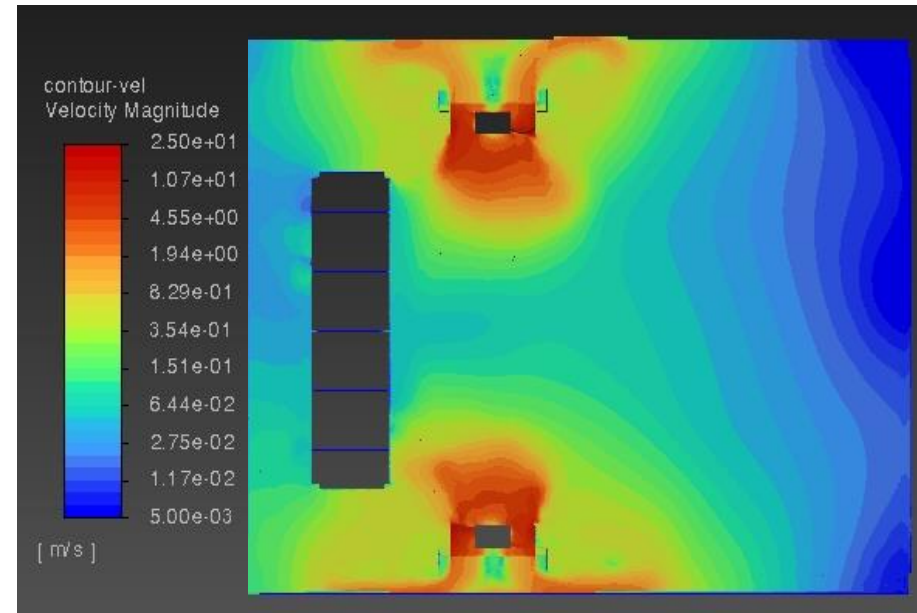
Central crystals reached thermal equilibrium at ~25°C when ambient temperature increased from 20°C to 25°C



Central crystals reached thermal equilibrium at ~20°C when ambient temperature decreased from 25°C to 20°C



Temperature plot (right-side view of NPS enclosure and crystal array). Lower temperature (blue color) at cooling plate and fans 10°C



Velocity contour plot (right-side view of NPS enclosure and crystal array). Shows airflow due to fans, inside the detector and through the crystals



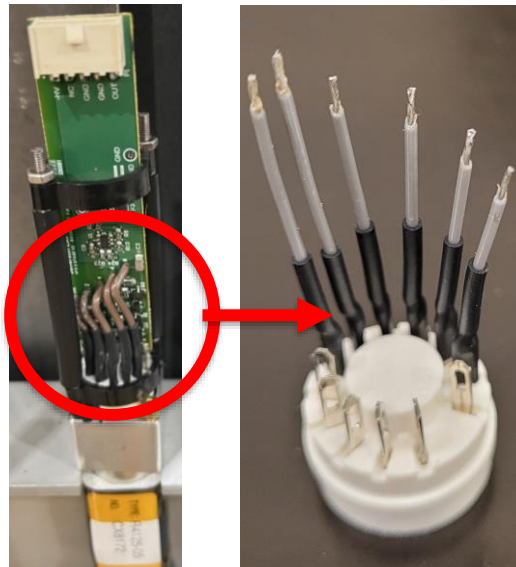


## Hardware support for FCAL 2

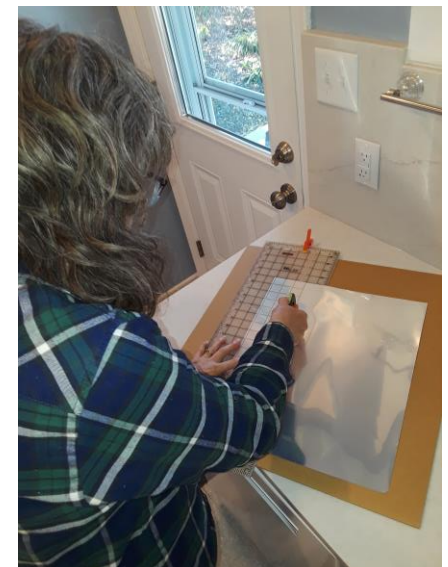
- Refurbished 72  $\text{PbWO}_4$  crystals from the *ComCal insert* of FCAL 1
  - Unwrapped enhanced specular reflector (ESR) from crystal
  - Removed light guide cup by submerging the light guide in diluted acetone for 2-3 hours
  - Cleaned crystal with alcohol
  - Visually inspected crystal for defects
  - Rewrapped with ESR if needed (112 total of 140)
- Pre-shaped 112 ESR foils in oven to wrap refurbished crystals
- Wrapped 833  $\text{PbWO}_4$  **SICCAS (Chinese) and CRYTUR (Czech Republic)** crystals with ESR foil and Tedlar
- Soldering PMT (Hamamatsu R41253355027) divider base connectors with wires to provide high voltage to different dynodes and the photocathode (585 of ~1750 completed)



Mindy Leffel soldering wires to PMT divider base connector



Left: Populated PMT divider, right: connector



Mary Ann Antonioli cutting ESR film to size

# EIC - Beampipe Test Stand

McMullen, Jacobs, and Campero

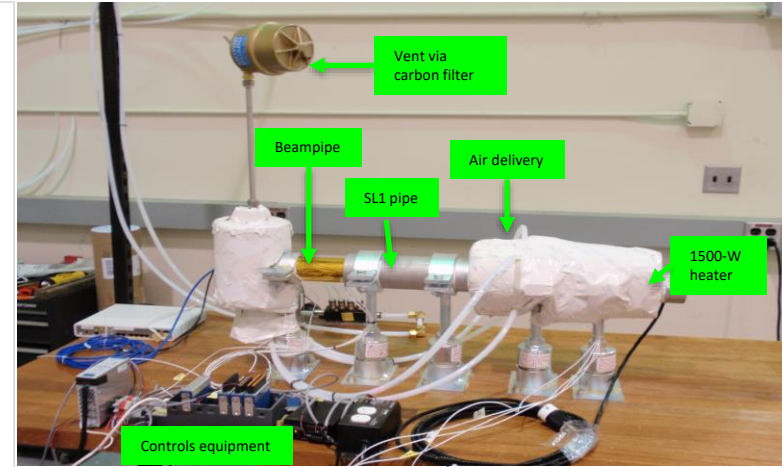
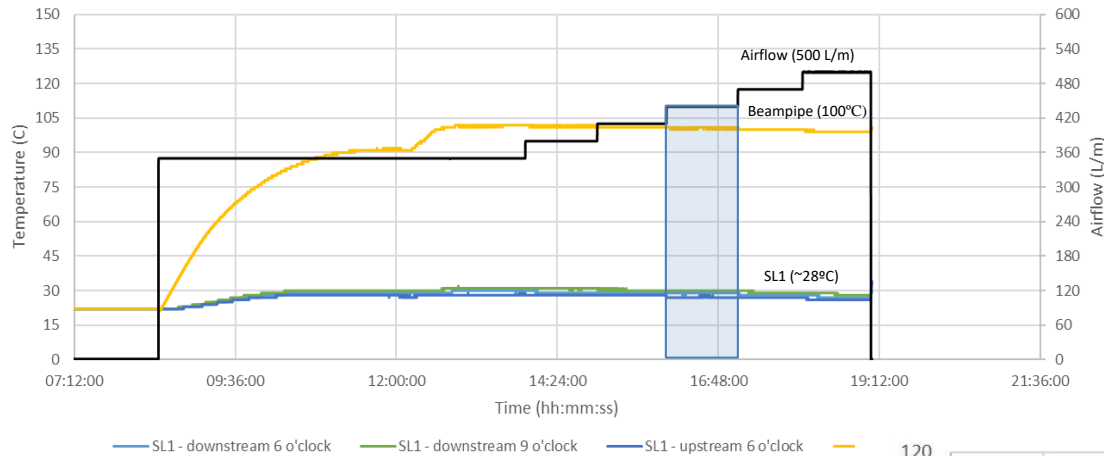


## Volumetric flow rate test to cool silicon layer 1 below 30°C with 20°C ambient air

- Test with six layers of thermal reflector (0.078" thickness) and beamline temperature at 100°C
- **Temperature of Al pipe that represents silicon layer 1 is ~30°C for airflow of ~450 L/m**

[DSG Note 2023-29](#) [DSG Note 2023-26](#) [DSG Talk 2023-01](#)

EIC Thermal Test Stand - 2023-09-21 Flow Test

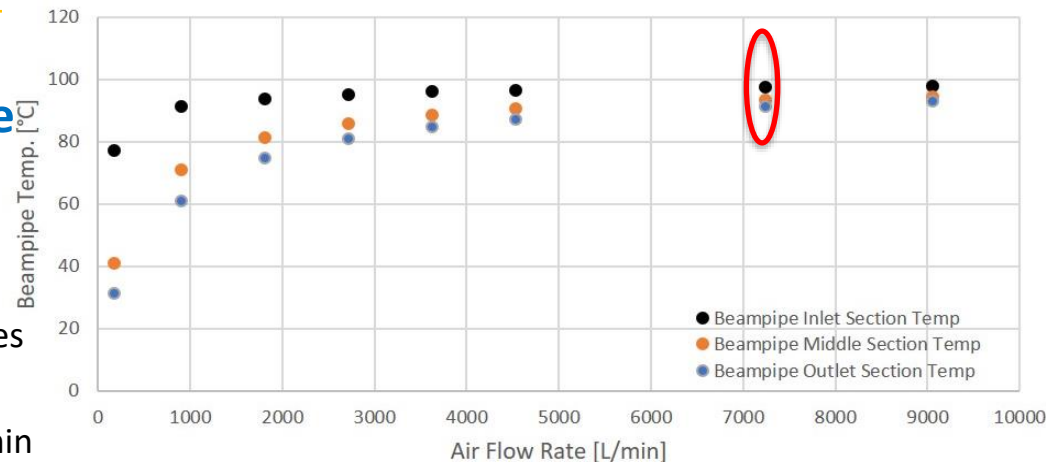


Test Stand

Plot shows airflow, beampipe temperature, and SL1 temperature

## Ansys simulation of 9-m long beampipe

- 9-m long beryllium beam pipe model with three layers of Kapton insulator (0.39 mm)
- Simulated temperature changes along beampipe when inlet is at 100°C for eight different inlet velocities
- Temperature of the inlet, middle, and outlet regions converge to 100°C for volumetric flow rate >7250 L/min



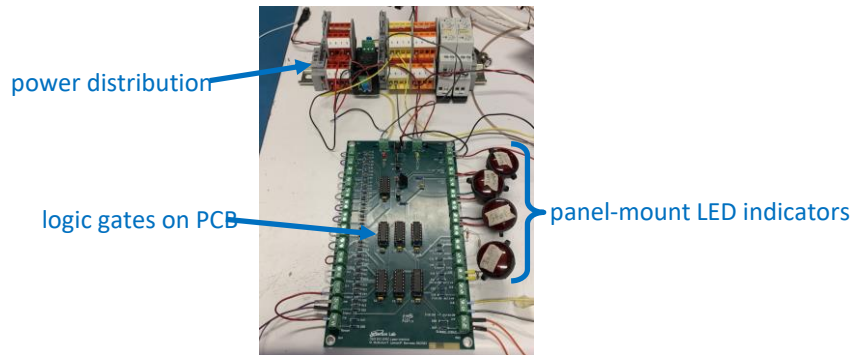
# EIC – DIRC and RICH

Lemon, McMullen, Jacobs, and Bonneau



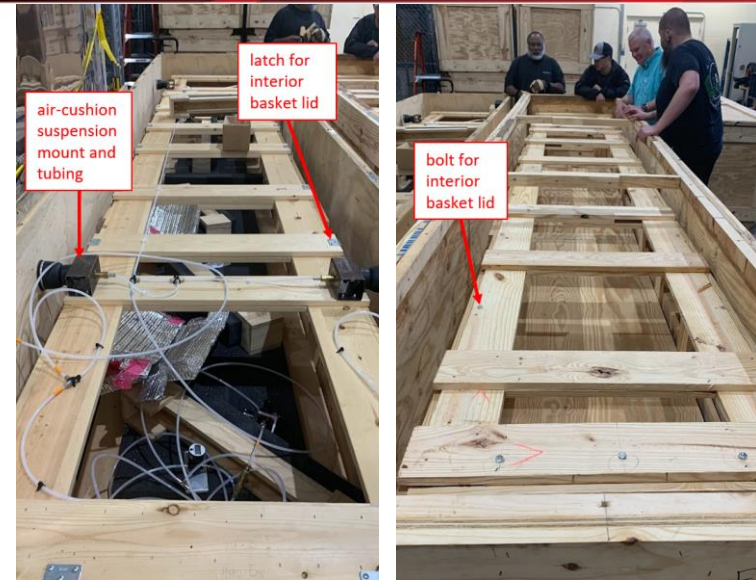
## Designing laser test lab and associated peripherals

- Designed, prototyped, fabricated, and debugged laser interlock system

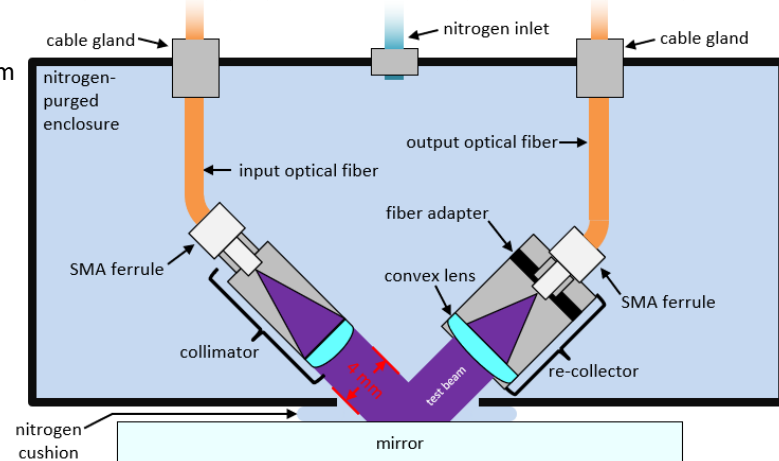


Assembled laser interlock PCB

- Designed photodiode readout circuit
- Developed Laser Operational Safety Procedure and training course for project
- Reviewing modifications to quartz bar shipping crates
  - Six crates received from vendor do not have necessary air-cushioned suspension system, foam for additional padding, and hand-removable latches
- Proposed design for mirror-reflectivity measurements for dual-radiator and proximity-focusing RICHs
  - Reflectivity probe on hand is not rated for UV and can be irreversibly damaged in as little as three hours, reducing fibers' transmissivity to 30%
  - Beam mainly propagated through UV-rated optical fibers
  - Collimator adapts diverging light from fiber to a 4-mm diameter beam
  - Light reflects off mirror at a 45° incident angle
  - Beam is re-collected into an optical fiber for routing to spectrometer using a convex lens and fiber adapter mounted in a lens tube



Left: Shipping crate previously used to transport quartz bars with all necessary suspension and padding  
Right: New shipping crate with no suspension and padding



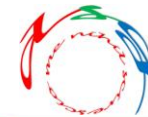
Design of proposed reflectivity probe for deep UV

[DSG Note 2023-39](#)



# DSG R&D - Phoebus Alarm System

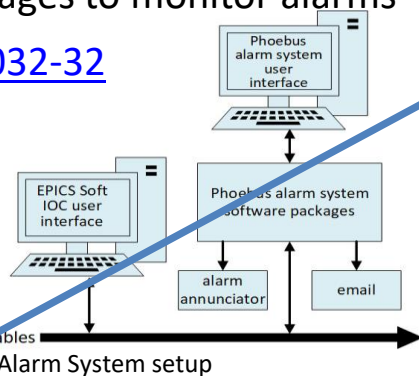
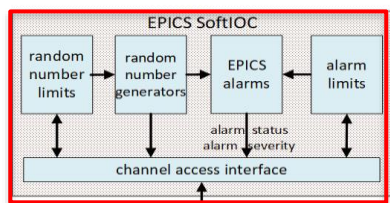
Bonneau



## Implementing Phoebus alarm system with EIC DIRC interlock

- Programmed applications in EPICS softIOC to simulate detector signals and Phoebus alarm system software packages to monitor alarms

DSG Notes [2023-23](#) & [2032-32](#)



**Alarm Summary**

PV name	Crystal read	HIHI set	HIHI read	HIGH set	HIGH read	LOW set	LOW read	LOLO set	LOLO read	Alarm status	Alarm severity	Scan rate	range [°C]	Min T [°C]	Max T [°C]	
hncps_hdk_cz1_back	0	18.83	23.00	23.00	22.99	22.99	14.99	14.99	15.00	15.00	NO_ALARM	NO_ALARM	1 second	8	15	23.00

**PV Alarm Status Tree**

- Crystal Zone Back Temperatures
  - Crystal Zone Back Temperature 1
  - Crystal Zone Back Temperature 2
  - Crystal Zone Back Temperature 3
  - Crystal Zone Back Temperature 4
  - Crystal Zone Back Temperature 5
  - Crystal Zone Back Temperature 6
- Crystal Zone Chiller Coolant
- Crystal Zone Front Temperatures
  - Detector Frame Dew Points
  - Detector Frame Humidity
  - Electronics Zone Chiller Coolant
  - Electronics Zone Temperatures
  - Hall Dew Points
  - Hall Humidity
  - Hall Temperatures

**Unacknowledged Alarms**

PV	Description	Alarm Severity	Alarm Status	Alarm Time	Alarm Value	PV Severity	PV Status
hncps_hdk_cz1_back_1	Crystal Zone Back Temperature 1	MAJOR	LOLO_ALARM	2023-08-18 22:08:05.044	15.0	OK	NO_ALARM

**Acknowledged Alarms**

PV	Description	Alarm Severity	Alarm Status	Alarm Time	Alarm Value	PV Severity	PV Status
hncps_hdk_cz1_back_2	Crystal Zone Back Temperature 2	MINOR	HIGH_ALARM	2023-08-19 02:11:33.044	20.0	OK	NO_ALARM

Overview screen simulated data

## EPICS Soft IOC User Interface

**PV Value**      **Alarm Limits**      **Alarm Status**      **SoftIOC Control** 95%

**Back Crystal Zone Temperature Sensor Alarm Testing [°C]**

Crystal read	HIHI set	HIHI read	HIGH set	HIGH read	LOW set	LOW read	LOLO set	LOLO read	Alarm status	Alarm severity	Scan rate	range [°C]	Min T [°C]	Max T [°C]
0	18.83	23.00	23.00	22.99	22.99	14.99	14.99	15.00	NO_ALARM	NO_ALARM	1 second	8	15	23.00
5	17.20	23.00	23.00	20.00	20.00	5.00	5.00	0.00	NO_ALARM	NO_ALARM	1 second	5	15	20.00
10	18.61	23.00	23.00	20.00	20.00	5.00	5.00	0.00	NO_ALARM	NO_ALARM	1 second	5	15	20.00
15	17.60	23.00	23.00	20.00	20.00	5.00	5.00	0.00	NO_ALARM	NO_ALARM	1 second	5	15	20.00
20	19.45	23.00	23.00	20.00	20.00	5.00	5.00	0.00	NO_ALARM	NO_ALARM	1 second	5	15	20.00

Close-up of EPICS user interface showing monitored values, alarm limits, status, severity, and scan rate

**Hall-C-NPS Alarm Area Panel**

- Crystal Zone Back Temperature (Red)
- Crystal Zone Chiller Coolant (Green)
- Crystal Zone Cooling Temperatures (Green)
- Crystal Zone Front Temperatures (Yellow)
- Detector Frame Dew Points (Green)
- Detector Frame Humidity (Green)
- Detector Frame Temperatures (Green)
- Electronics Zone Chiller Coolant (Green)
- Electronics Zone Temperatures (Green)
- Hall Dew Points (Green)
- Hall Humidity (Green)
- Hall Temperatures (Green)

Alarm summary. Red indicates major severity, amber minor severity

# Summary



## In the areas of

- system design
- research and development
- coding
- test and measurement
- electronics design
- fabrication
- assembly

**dsg** made contributions  
to several Hall projects and  
to EIC

